Atmel ATPL100A



FSK Power Line Communications SoC

SUMMARY DATASHEET

Features

- Core
 - ADD8051C3A enhanced 8051 core
 - Speedups up to x5 vs. standard 8051 microcontroller
- 128Kbytes internal SRAM
- In-circuit serial flash programming
- Auto boot-loading program from serial flash
- Media Access Control
 - · Convolutional and block (FEC) channel coding, Viterbi decoding
 - Hardware CRC error detection and FEC error correction
 - By-pass mode to support earlier no-MAC FSK modem software
- Modem
 - Power Line Carrier Modem for 50 and 60 Hz mains
 - 8 Programmable Carrier Frequencies from 60 to 132.5KHz
 - Baud rate Selectable: 600 to 4800 bps
 - Half Duplex communication
 - Receiver Sensitivity: Up to 44dBµVrms
- Peripherals
 - Three 2-wire UARTs
 - Two SPI. SPI to serial flash and External RTC. Buffered SPI to external metering IC
 - Programmable Watchdog
 - Quad dimmer in/out
 - 24x8/28x4 segments LCD driver
 - Up to 20 I/O lines
- Package
 - 144-lead LQFP, 16 x 16 mm, pitch 0.4 mm
 - · Pb-free and RoHS compliant
- Typical Applications
 - Automated Meter Reading (AMR) & Advanced Meter Management (AMM)
 - Street lighting
 - Home Automation

Description

The ATPL100A is a Power Line Communications System on Chip. It implements a full PLC node using FSK modulations and includes a hardwired Medium Access Controller (ADD1210). It has been developed to reduce the CPU computational load in PLC systems. Thus, the microcontroller is free to be used in the applications tasks.

MAC functional capabilities of ATPL100A (performed in ADD1210 Medium Access Controller) involve the construction of message packets, adding convolutional or FEC (Forward Error Correction) codes to bytes and FCS (Frame Check Sequence) to packets. In reception, the MAC provides frame detection and Viterbi decoding or FCS and FEC correction.

ATPL100A MAC design is versatile and allows users to create a wide range of datagram structures. The MAC can be set in a bypass mode allowing direct connection between the microcontroller and the modem to support old FSK software that doesn't include the MAC.

ATPL100A PLC modem (ADD1310) can use a single power supply of 3.3V and a few external components. It supports several Analog Front End (AFE) configurations suitable for Automatic Meter Reading (AMR) or Home Automation. It can replace the traditional analog PLC modem and can use the same software libraries or a simplified version if the hardwired MAC is used.

ATPL100A core (ADD8051C3A) includes all features of the standard 8051, with an average speed up x5 and some additional features.

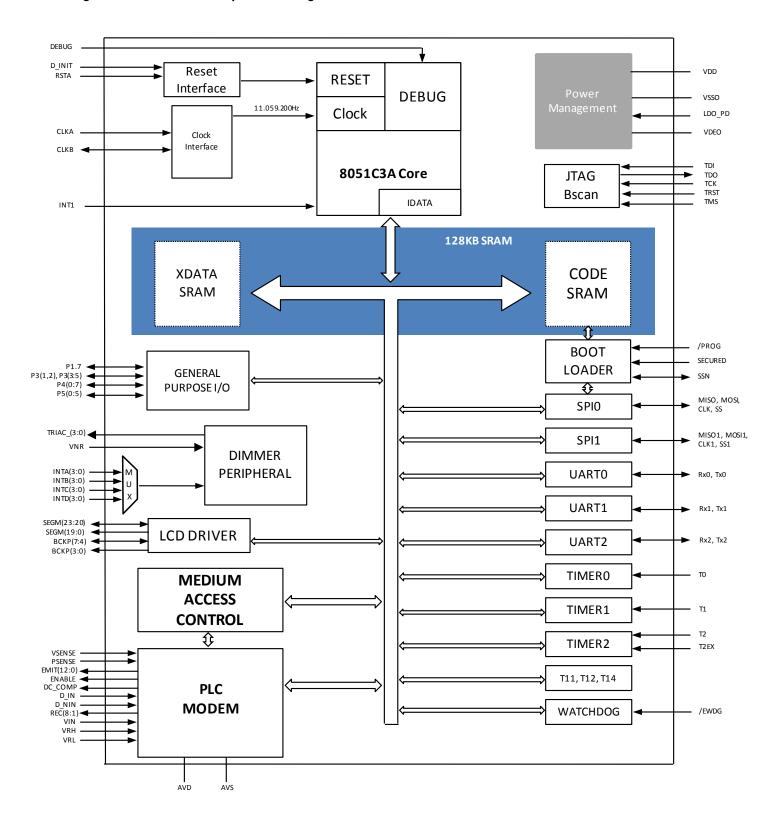
The microcontroller includes some specific peripherals as a 4 input / 4 output dimmer for power regulation (phase angle control), also being able to generate a PWM (Pulse-Width Modulation) control.

A flash program loader allows to store the microcontroller program in a standard SPI serial flash memory and to execute it from internal SRAM. In the start-up process the program is uploaded from serial flash to the internal 128Kbytes of SRAM before start execution, after start-up the free space in the serial flash can be used to store application data. ATPL100A includes an encryption engine for code protection. Using a larger flash, several programs can be stored at the same time and the microcontroller can switch from one program to another, this feature could be used to reprogram the SoC using PLC downloading.



1. Block Diagram

Figure 1-1. ATPL100A 144-pin Block Diagram

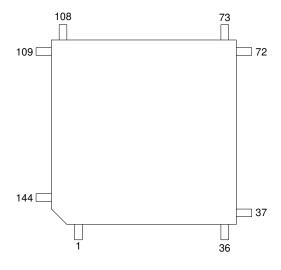




2. Package and Pinout

2.1 144-Lead LQFP Package Outline

Figure 2-1. Orientation of the 144-Lead Package





2.2 144-Lead LQFP Pinout

Table 2-1. ATPL100A 144-Lead LQFP pinout

1	P3.3/INT1	
2	VCC	
3	GND	
4	GND	
5	GND	
6	TDI	
7	TDO	
8	TCK	
9	TMS	
10	TRST	
11	D_INIT	
12	RSTA	
13	/PROG	
14	SECURED	
15	/EWDG	
16	DEBUG	
17	VCC	
18	CLKEB	
19	GND	
20	CLKEA	
21	VCC	
22	GND	
23	GND	
24	VDEO	
25	VDEO	
26	VSSO	
27	LDO_PD	
28	VDD	
29	GND	
30	VCC	
31	VSENSE	
32	PSENSE	
33	VNR	
34	TRIAC_3	
35	TRIAC_2	
36	TRIAC_1	

37	TRIAC_0
38	P5.5/TXD1/INTA1
39	P5.4/RXD1/INTA0
40	P4.7/T2EX/INTA3
41	P4.6/T2/INTA2
42	P1.7/SSN
43	VCC
44	GND
45	EMIT.0
46	EMIT.1
47	EMIT.2
48	VCC
49	GND
50	EMIT.3
51	EMIT.4
52	EMIT.5
53	EMIT.6
54	VCC
55	GND
56	EMIT.7
57	EMIT.8
58	EMIT.9
59	EMIT.10
60	VCC
61	GND
62	EMIT.11
63	EMIT.12
64	VCC
65	GND
66	P3.1/TXD0
67	P3.0/RXD0
	i ————
68	P4.5/MISO1/INTB3
	P4.5/MISO1/INTB3 P4.4/MOSI1/INTB2
68	
68 69	P4.4/MOSI1/INTB2

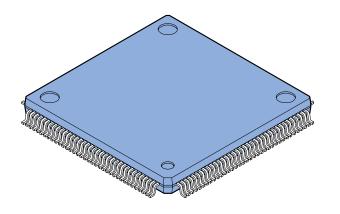
73	P4.0/RXD2
74	VCC
75	GND
76	SEGM_23/INTC3
77	SEGM_22/INTC2
78	SEGM_21/INTC1
79	SEGM_20/INTC0
80	SEGM_19
81	SEGM_18
82	SEGM_17
83	SEGM_16
84	SEGM_15
85	SEGM_14
86	SEGM_13
87	SEGM_12
88	SEGM_11
89	VDD
90	VCC
91	GND
92	SEGM_10
93	SEGM_9
94	SEGM_8
95	SEGM_7
96	SEGM_6
97	SEGM_5
98	SEGM_4
99	SEGM_3
100	SEGM_2
101	SEGM_1
102	SEGM_0
103	VCC
104	GND
105	BCKP_7/SEGM_27/INTD3
106	BCKP_6/SEGM_26/INTD2
107	BCKP_5/SEGM_25/INTD1
108	BCKP_4/SEGM_24/INTD0

109	BCKP_3
110	BCKP_2
111	BCKP_1
112	BCKP_0
113	GND
114	DC_COMP
115	VCC
116	ENABLE
117	GND
118	DNIN
119	DIN
120	REC_1
121	REC_2
122	REC_3
123	REC_4
124	REC_5
125	REC_6
126	REC_7
127	REC_8
128	VCC
129	GND
130	VRL
131	VIN
132	VRH
133	AVD1
134	AVS1
135	AVD2
136	AVS2
137	VCC
138	GND
139	P5.3/MISO0
140	P5.2/MOSI0
141	P5.1/SPICLK0
142	P5.0/SS0
143	P3.5/T1
144	P3.4/T0



3. Mechanical Characteristics

Figure 3-1. 144-lead LQFP Package Mechanical Drawing



Lead pitch 0.40 mm

Pa ckage width package length 16.0 · 16.0 mm

Lead shape Gullwing

Sealing method Plastic mold

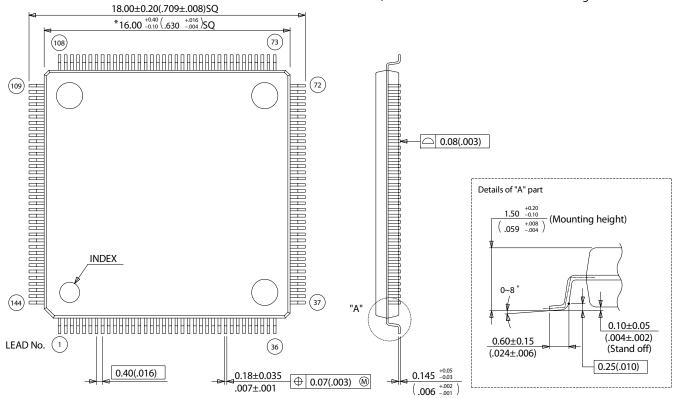
Mounting height 1.70 mm MAX

We ight 0.88 g

Note 1) *: These dimensions include resin protrusion. Resin protrusion is +0.25(.010)Max(each side).

Note 2) Pins width and pins thickness include plating thickness.

Note 3) Pins width do not include tie bar cutting remainder.



Dimensions in mm (inches). Note: The values in parentheses are reference values.



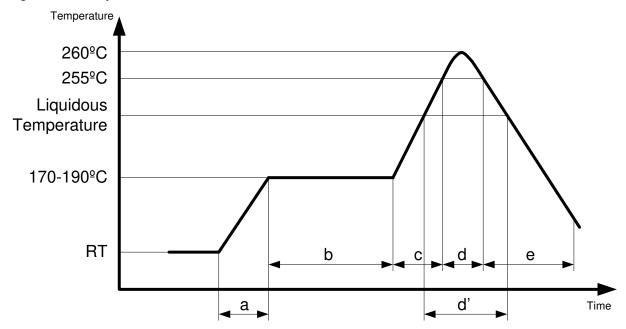
4. Recommended mounting conditions

4.1 Conditions of Standard Reflow

Table 4-1. Conditions of standard Reflow

Items	Contents	
Method	IR(Infrared Reflow)/Convection	
Times	2	
Floor Life	Before unpacking	Please use within 2 years after production
	From unpacking to second reflow	Within 8 days
	In case over period of floor life	Baking with 125°C +/- 3°C for 24hrs +2hrs/-0hrs is required. Then please use within 8 days. (please remember baking is up to 2 times)
Floor Life Condition	Between 5°C and 30°C and also below 70%RH required. (It is preferred lower humidity in the required temp range.)	

Figure 4-1. Temperature Profile



Note: H rank: 260°C Max

a: Average ramp-up rate: 1°C/s to 4°C/s

b: Preheat & Soak: 170°C to 190°C, 60s to 180s

c: Average ramp-up rate: 1ºC/s to 4ºC

d: Peak temperature: 260°C Max, up to 255°C within 10s

d': Liquidous temperature: Up to 230°C within 40s or

Up to 225 $^{\circ}$ C within 60s or

Up to 220°C within 80s

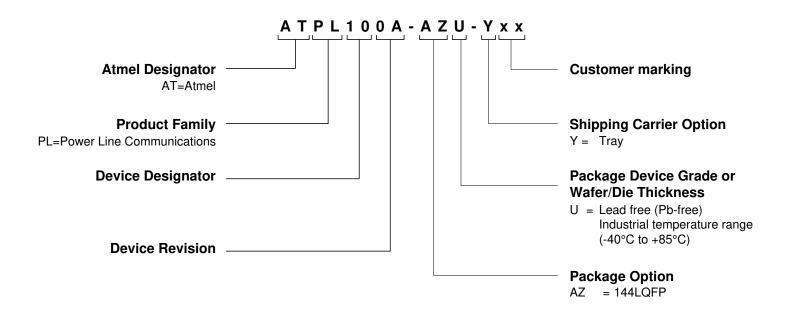
e: Cooling: Natural cooling or forced cooling



5. Ordering Information

Table 5-1. Atmel ATPL100A Ordering Codes

Atmel Ordering Code	Package	Package Type	Temperature Range
ATPL100A-AZU-Y	144 LQFP	Pb-Free	Industrial (-40°C to 85°)





6. Revision History

Doc. Rev.	Date	Comments
1.00	30/03/2012	Initial release





Enabling Unlimited Possibilities™

Atmel Corporation

2325 Orchard Parkway San Jose, CA 95131

Tel: (+1)(408) 441-0311 **Fax:** (+1)(408) 487-2600

www.atmel.com

Atmel Asia Limited

Unit 01-5 & 16, 19F BEA Tower, Millennium City 5 418 Kwun Tong Road Kwun Tong, Kowloon HONG KONG

Tel: (+852) 2245-6100 **Fax:** (+852) 2722-1369

Atmel Munich GmbH

Business Campus Parkring 4 D-85748 Garching b. Munich

GERMANY

Tel: (+49) 89-31970-0 **Fax:** (+49) 89-3194621

Atmel Japan G.K.

16F Shin-Osaki Kangyo Building 1-6-4 Osaki

Shinagawa-ku, Tokyo 141-0032

JAPAN

Tel: (+81)(3) 6417-0300 **Fax:** (+81)(3) 6417-0370

© 2012 Atmel Corporation. All rights reserved. / Rev.: Product Description

Atmel[®], logo and combinations thereof, and others are registered trademarks or trademarks of Atmel Corporation or its subsidiaries. Other terms and product names may be trademarks of others.

Disclaimer: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN THE ATMEL TERMS AND CONDITIONS OF SALES LOCATED ON THE ATMEL WEBSITE, ATMEL ASSUMES NO LIBILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS AND PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and products descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.